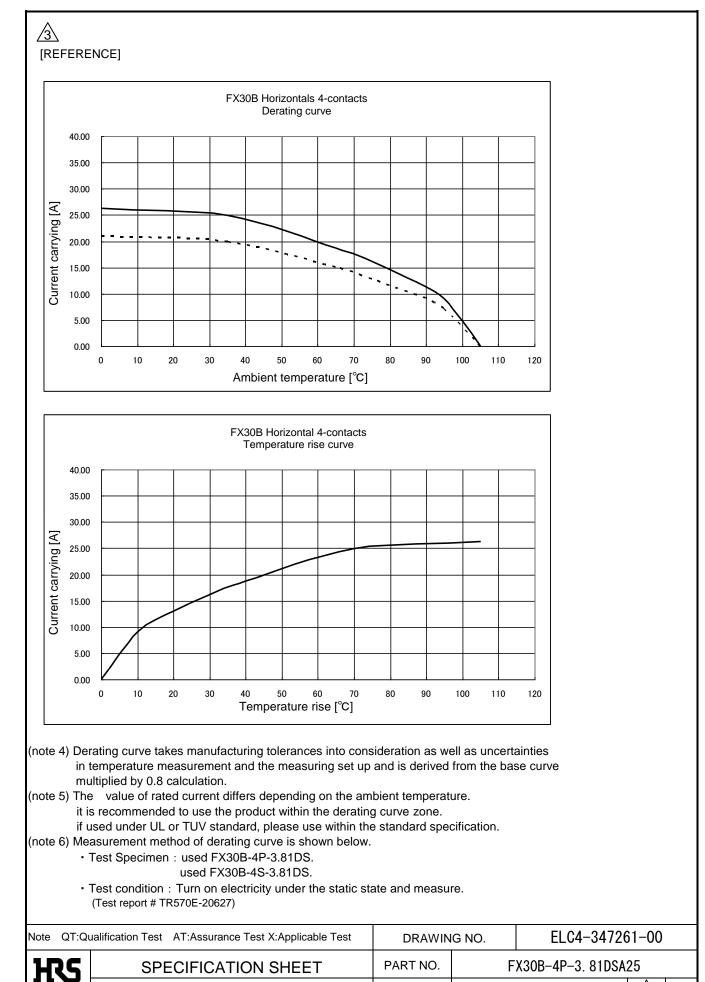
Applica	able stand	ard 🔬	UL : UL1977, C-UL : CSA2	22.2 No.1	182.3-M1	987, -	TÜV : EI	N61984	4:2009 ⁽³⁾		
	Voltage 3		250 V AC/DC(UL/C-UL) 150V AC/DC(TÜV)			Operating Temperature Range Operating Humidity Range		-55 °C to 10	-55 °C to 105 °C ⁽¹⁾		
RATING					F				Relative Humidity 85% max (Not dewed)		
	Current		20 A (AMBIENT TEPM 25°C) 13 A (UL/C-UL)		Storag Tempe		ture Ra	Range -10 °C to 60)
		<u>/</u> 2\	15 Å (TÜV)			-	Humidity Range 40 % to 70 %				
				CIFICA	TION	S					
ITE		TEST METHOD				REQUIREMENTS					AT
CONSTRU											
General Examination		Visually and by measuring instrument.				According to drawing.				×	×
Marking ELECTRIC CHARACT		Confirmed visually.									×
										-	-
Contact Resis		10 mA(DC or 1000Hz)				2 m Ω MAX.				×	
Insulation Resistance		1000 V DC.				1000 MΩ MIN.				×	-
Voltage Proof		1800 V AC for 1 min. No flashover or breakdown. ACTERISTICS								×	-
	CAL CHAR									<u> </u>	<u> </u>
Insertion and Withdrawal Forces		Measured by applicable connector.				Insertion Force: 20 N MAX. Withdrawal Force: 0.8 N MIN.				×	-
Mechanical Operation		100 times insertions and extractions.				(1) Contact Resistance: 5 m Ω MAX.				×	-
						 ② No damage, crack and looseness of parts. 					
Vibration		Frequency 10 to 55 to 10Hz, approx 5min				1 No electrical discontinuity of 1 μ s.					-
		Single amplitude : 0.75 mm, 10 cycles for 3 axial directions.				 No damage, crack and looseness of parts. 					
Shock		490 m/s ² , duration of pulse 11 ms,				1				×	-
			both directions in 3 axial di	rections.							
ENVIRON	IENTAL C					0				r	r
Damp Heat)	Exposed at 40±2 °C, 90 ~ 95 %, 96 ±4h.				0			e: 5mΩ MAX.	×	-
(Steady State) Rapid Change of		T				<u> </u>			nce: 1000 M Ω MIN. and looseness of parts.	×	
Temperature		Temperature $-55 \rightarrow +105 \ ^{\circ}C$ Time $30 \rightarrow 30$ min. under 5 cycles. (Relocation time to chamber: within 2~3 MIN)					uamaye	, crack			
Dry heat		Exposed at +105 \pm 2°C for 96 \pm 4h.				-				×	-
Cold		Exposed at -55±2°C for 96±4h.								×	-
Sulfur Dioxide		Exposed at 25±2°C, 75±5%RH,				① Contact Resistance: 5mΩ MAX. ×					-
		25 PPM for 96h±4h.				② No defect such as corrosion which impairs the function of connector.					
Resistance to		Solder bath : Solder temperature $260\pm5^{\circ}$ C				No deformation of case of excessive looseness				×	-
Soldering Heat		for immersion, duration 10±1sec. Soldering irons : 380°C MAX. for 10 sec.				of the terminal.					
Solderability			lered at solder temperature $240\pm3^{\circ}$ C mmersion, duration 3 sec.			A new uniform coating of solder shall cover a minimum of 95 % of the surface being immersed.					-
COUNT	r Di	ESCRIPTIC	SCRIPTION OF REVISIONS		DESIC	SIGNED		CHECKED	DATE		
3 3					TS. 0	OONO H		HT. YAMAGUCHI	16. 12. 16		
	⁾ Include tempera		ised by current-carrying. n storage state pre assembly to PCB. rminals :dip solder contacts.			APPROVED CHECKED DESIGNED		-	HS. OKAWA)3. 07
	for the unused	product befor							KI. HIROKAWA	13. 03. 07 13. 03. 07	
									DK. AIMOTO	13. 03. 07	
			to JIS-C-5402,IEC60512.					VVIN	DK. AIMOTO	DK. AIMOTO 13. 03. 0 ELC4-347261-00	
		fication Test AT:Assurance Test X:Applicable Te									
RS		PECIFICATION SHEET			PART NO.		FX30B-4P-3. 81DSA25			~	
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FORM HD0011-2-1



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